

RESISTOR

CVD DIAMOND CHIP 2.25 WATTS, WRAPPED



DATA SHEET

PART SERIES: CR0505DX5W2

SHEET 1 OF 2
Dwg 1013125

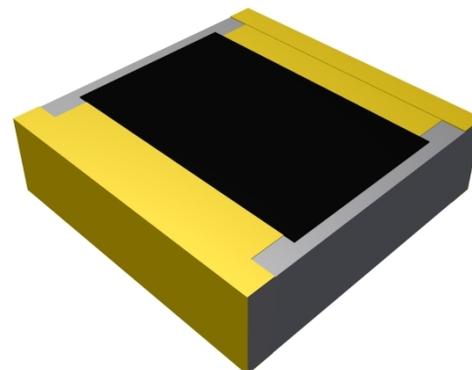
EN 15-0513
Revision A

FEATURES

- Small Size - Light Weight
- Highest Thermal Performance Possible
- Excellent Peak Power Capability
- Rugged Passivated TaN Film
- Moisture Resistant
- Pure Gold Input Pads
- Wire Bondable or Solderable
- High Power

APPLICATIONS

- Broadcast
- Higher Power Filters
- High Power Amplifiers
- Instrumentation
- Isolators
- Military
- Satellite Communications
- Phased Array Radar



GENERAL DESCRIPTION

Diamond Rf Resistives ® offer extremely high power ratings and smallest size watt-per-watt of any resistor configuration on the planet. These resistors may be used in applications up to 30 GHz and are ideal for military and space applications because of their high power capability, broad frequency response and small, light-weight size. These resistors are processed using all thin film construction and have pure thin film gold terminals that are both wire bondable and solderable. They are ideal for peak power applications. High reliability tested versions per MIL-PRF-55342 are also available. Select from tape and reel or waffle packaging. These products are S-level approved. They also meet NASA out-gassing requirements for space applications.

ORDERING INFORMATION

Part Identifier:

CR0505DX5W2

Resistance

SPECIFICATIONS

1.0 ELECTRICAL

Resistance:	50 & 100 Ω , \pm 5%
Frequency Range:	DC – 18 GHz
Capacitance:	0.30 pF Typical
Input Power CW:	2.25 Watts
Peak Power:	22.5 Watts (1 μ s pulse width/1% duty cycle)

2.0 ENVIRONMENTAL

Operating Temperature:	-55 °C To +125 °C
Temperature Coefficient:	\pm 200 PPM/°C Max

3.0 MARKING

Unit Marking:	None
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4.0 QUALITY ASSURANCE

- Sample Inspect Per MIL-STD-105, Level II, 1.0% AQL
- Visual and Mechanical Inspection for Conformance to Outline Drawing
- Measure DC Resistance
- Data Retention - Standard

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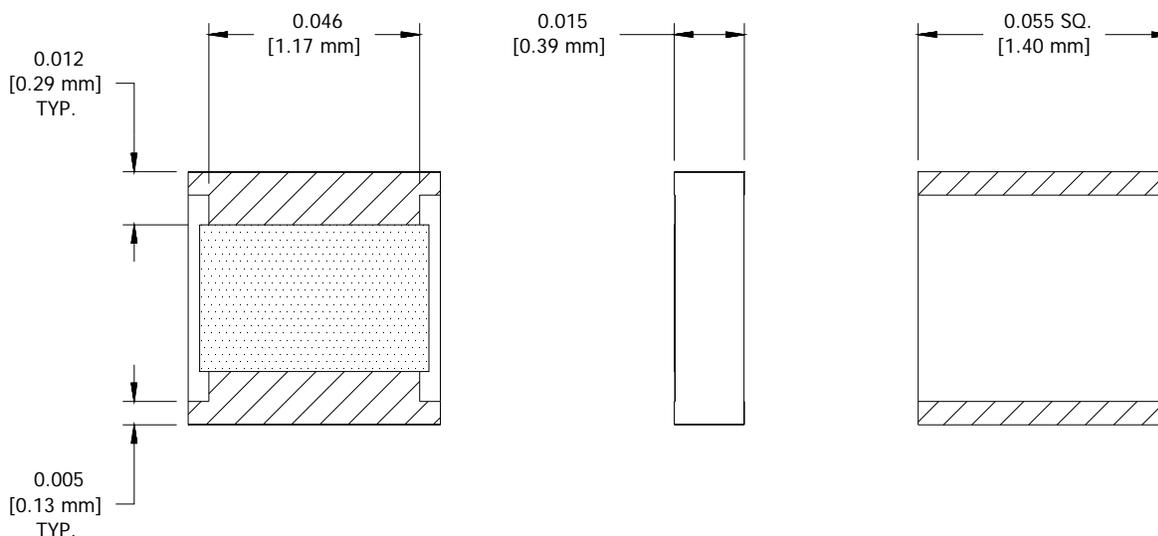
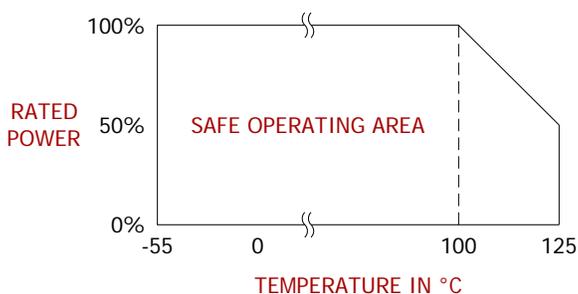
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5.0 PACKAGING

Standard: Waffle Packaging
Optional: Tape and Reel

6.0 MECHANICAL

Substrate Material: CVD Diamond
Resistive Element: Thin Film
Terminal/Material: Gold over Nickel
Ground Plane Material: Gold over Platinum
Metric Dimensions: Provided for reference only



Unless Otherwise Specified: TOLERANCE: X.XX = ± 0.01 X.XXX = ± 0.005